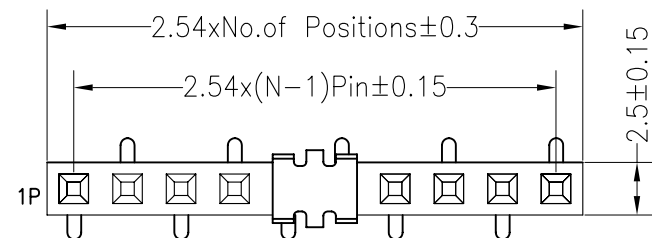
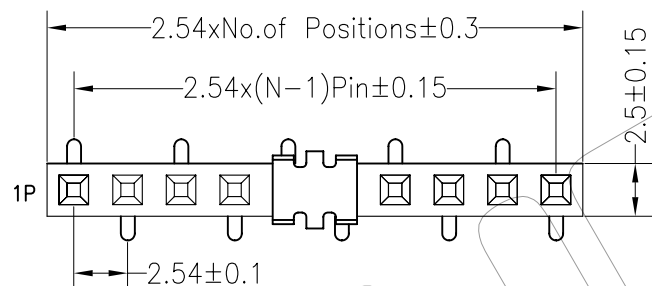


RoHS

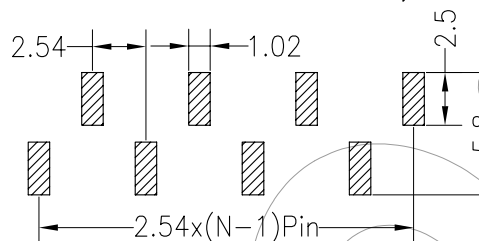


TYPE01

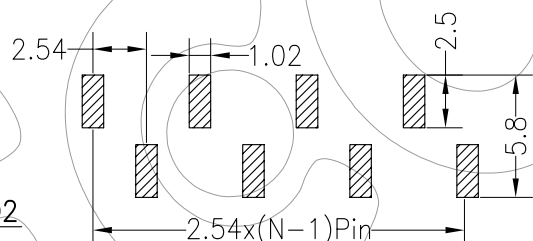


TYPE02

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



TYPE01



TYPE02

SPECIFICATIONS

Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)

Ordering Information

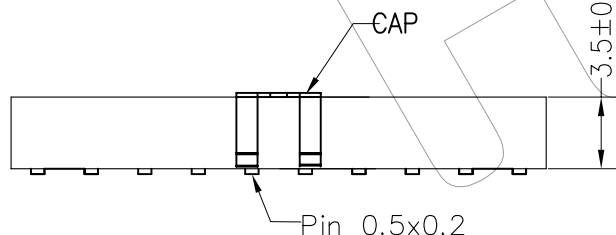
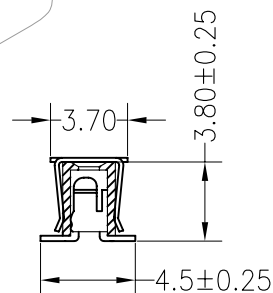
HC-FH43501XX X N XX M U X 0X(1,2)

No.of
Pins
Per Row
1*40

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
F=BK-LCP

Contact Plating
G0:Gold Flash
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar



OPERATION

X.X ±0.30

X.XX ±0.20

X.XXX ±0.10

Angle ±3°

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

1/1

HECON

东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-FH43501XXNXXMUXOX(1,2)

TITLE:

2.54mm H3.5 Single Row SMT Female Header

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

DIM

TOL

APPROVE

PROJ.

1/1

TITLE:

2.54mm H3.5 Single Row SMT Female Header